



Material Content Data Sheet



Sales Product Name		BB 914 E6327		Issued		25. September 2017		
MA#		MA000942412						
Package		PG-SOT23-3-3		Weight*		8.74 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		36	
	noble metal	gold	7440-57-5	0.031	0.35		3539	
	inorganic material	silicon	7440-21-3	0.264	3.02	3.37	30225	33800
leadframe	non noble metal	nickel	7440-02-0	1.142	13.07		130678	
	non noble metal	iron	7439-89-6	1.578	18.05	31.12	180461	311139
wire	noble metal	gold	7440-57-5	0.016	0.18	0.18	1780	1780
encapsulation	organic material	carbon black	1333-86-4	0.087	1.00		9983	
	inorganic material	antimonytrioxide	1309-64-4	0.131	1.50		14974	
	plastics	brominated resin	-	0.164	1.87		18718	
	plastics	epoxy resin	-	1.364	15.60		155983	
	inorganic material	silicondioxide	60676-86-0	3.709	42.43	62.40	424275	623933
leadfinish	non noble metal	tin	7440-31-5	0.150	1.71	1.71	17117	17117
plating	noble metal	silver	7440-22-4	0.107	1.22	1.22	12231	12231
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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